

2N4403







PNP General Purpose Amplifier

This device is designed for use as a general purpose amplifier and switch requiring collector currents to 500 mA.

Absolute Maximum Ratings*

TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{CEO}	Collector-Emitter Voltage	40	V
V _{CBO}	Collector-Base Voltage	40	V
V _{EBO}	Emitter-Base Voltage	5.0	V
Ic	Collector Current - Continuous	600	mA
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

1) These ratings are based on a maximum junction temperature of 150 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics

TA = 25°C unless otherwise noted

Symbol	Characteristic	Max		Units
		2N4403	*MMBT4403	
P _D	Total Device Dissipation Derate above 25°C	625 5.0	350 2.8	mW mW/°C
R _θ JC	Thermal Resistance, Junction to Case	83.3		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	357	°C/W

^{*}Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06."

PNP General Purpose Amplifier (continued)

ns

Symbol	Parameter	Test Conditions	Min	Max	Units
OFF CHA	RACTERISTICS				
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage*	$I_C = 1.0 \text{ mA}, I_B = 0$	40		V
$V_{(BR)CBO}$	Collector-Base Breakdown Voltage	$I_C = 0.1 \text{ mA}, I_E = 0$	40		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_E = 0.1 \text{ A}, I_C = 0$	5.0		V
I _{BEX}	Base Cutoff Current	$V_{CE} = 35 \text{ V}, V_{EB} = 0.4 \text{ V}$		0.1	μΑ
I _{CEX}	Collector Cutoff Current	$V_{CE} = 35 \text{ V}, V_{BE} = 0.4 \text{ V}$		0.1	μΑ
ON CHAF	RACTERISTICS				
h _{FE}	DC Current Gain	$I_C = 0.1 \text{ mA}, V_{CE} = 1.0 \text{ V}$	30		
		$I_C = 1.0 \text{ mA}, V_{CE} = 1.0 \text{ V}$	60		
		$I_C = 10 \text{ mA}, V_{CE} = 1.0 \text{ V}$ $I_C = 150 \text{ mA}, V_{CE} = 2.0 \text{ V}^*$	100 100	300	
		$I_C = 500 \text{ mA}, V_{CE} = 2.0 \text{ V}^*$	20	300	
V _{CE(sat)}	Collector-Emitter Saturation	$I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$		0.4	V
02(044)	Voltage*	$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$		0.75	V
$V_{BE(sat)}$	Base-Emitter Saturation Voltage	$I_C = 150 \text{ mA}, I_B = 15 \text{ mA}^*$	0.75	0.95	\ \ /
		I _C = 500 mA, I _B = 50 mA	0.73	1.3	V
	GNAL CHARACTERISTICS	I _C = 500 mA, I _B = 50 mA			
SMALL SI			200		MHz
	GNAL CHARACTERISTICS	I_C = 500 mA, I_B = 50 mA I_C = 20 mA, V_{CE} = 10 V, I_C = 100 MHz I_C = 0,			
f _T C _{cb}	GNAL CHARACTERISTICS Current Gain - Bandwidth Product	$\begin{split} I_C &= 500 \text{ mA}, \ I_B = 50 \text{ mA} \\ \\ I_C &= 20 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 100 \text{ MHz} \\ \\ V_{CB} &= 10 \text{ V}, \ I_E = 0, \\ f &= 140 \text{ kHz} \\ \\ V_{BE} &= 0.5 \text{ V}, \ I_C = 0, \end{split}$		1.3	MHz
f _T C _{cb} C _{eb}	GNAL CHARACTERISTICS Current Gain - Bandwidth Product Collector-Base Capacitance	$\begin{split} I_C &= 500 \text{ mA}, \ I_B = 50 \text{ mA} \\ \\ I_C &= 20 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 100 \text{ MHz} \\ \\ V_{CB} &= 10 \text{ V}, \ I_E = 0, \\ f &= 140 \text{ kHz} \\ \\ V_{BE} &= 0.5 \text{ V}, \ I_C = 0, \\ f &= 140 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \end{split}$		8.5	MHz pF
f⊤	GNAL CHARACTERISTICS Current Gain - Bandwidth Product Collector-Base Capacitance Emitter-Base Capacitance	$\begin{split} I_C &= 500 \text{ mA}, \ I_B = 50 \text{ mA} \\ \\ I_C &= 20 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 100 \text{ MHz} \\ \\ V_{CB} &= 10 \text{ V}, \ I_E = 0, \\ f &= 140 \text{ kHz} \\ \\ V_{BE} &= 0.5 \text{ V}, \ I_C = 0, \\ f &= 140 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \end{split}$	200	8.5 30	MHz pF pF
fr C _{cb} C _{eb} h _{ie}	GNAL CHARACTERISTICS Current Gain - Bandwidth Product Collector-Base Capacitance Emitter-Base Capacitance Input Impedance	$\begin{split} I_C &= 500 \text{ mA}, \ I_B = 50 \text{ mA} \\ \\ I_C &= 20 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 100 \text{ MHz} \\ \\ V_{CB} &= 10 \text{ V}, \ I_E = 0, \\ f &= 140 \text{ kHz} \\ \\ V_{BE} &= 0.5 \text{ V}, \ I_C = 0, \\ f &= 140 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \end{split}$	200	8.5 30 15	MHz pF pF kΩ
fr C _{cb} C _{eb} h _{ie} h _{re}	GNAL CHARACTERISTICS Current Gain - Bandwidth Product Collector-Base Capacitance Emitter-Base Capacitance Input Impedance Voltage Feedback Ratio	$\begin{split} I_C &= 500 \text{ mA}, \ I_B = 50 \text{ mA} \\ \\ I_C &= 20 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 100 \text{ MHz} \\ \\ V_{CB} &= 10 \text{ V}, \ I_E = 0, \\ f &= 140 \text{ kHz} \\ \\ V_{BE} &= 0.5 \text{ V}, \ I_C = 0, \\ f &= 140 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ \end{split}$	200 1.5 0.1	8.5 30 15 8.0	MHz pF pF kΩ
fr C _{cb} C _{eb} h _{ie} h _{re}	GNAL CHARACTERISTICS Current Gain - Bandwidth Product Collector-Base Capacitance Emitter-Base Capacitance Input Impedance Voltage Feedback Ratio Small-Signal Current Gain	$\begin{split} I_C &= 500 \text{ mA}, \ I_B = 50 \text{ mA} \\ \\ I_C &= 20 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 100 \text{ MHz} \\ \\ V_{CB} &= 10 \text{ V}, \ I_E = 0, \\ f &= 140 \text{ kHz} \\ \\ V_{BE} &= 0.5 \text{ V}, \ I_C = 0, \\ f &= 140 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ mA}, \ V_{CE} =$	200 1.5 0.1 60	8.5 30 15 8.0 500	MHz pF pF kΩ x 10 ⁻⁴
fr Ccb Ceb hie hre hfe	GNAL CHARACTERISTICS Current Gain - Bandwidth Product Collector-Base Capacitance Emitter-Base Capacitance Input Impedance Voltage Feedback Ratio Small-Signal Current Gain	$\begin{split} I_C &= 500 \text{ mA}, \ I_B = 50 \text{ mA} \\ I_C &= 20 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 100 \text{ MHz} \\ V_{CB} &= 10 \text{ V}, \ I_E = 0, \\ f &= 140 \text{ kHz} \\ V_{BE} &= 0.5 \text{ V}, \ I_C = 0, \\ f &= 140 \text{ kHz} \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ I_C &= 1.0 \text{ kHz} \\ $	200 1.5 0.1 60	8.5 30 15 8.0 500	MHz pF pF kΩ x 10 ⁻⁴
fT Ccb Ceb hie hre hoe	GNAL CHARACTERISTICS Current Gain - Bandwidth Product Collector-Base Capacitance Emitter-Base Capacitance Input Impedance Voltage Feedback Ratio Small-Signal Current Gain Output Admittance	$\begin{split} I_C &= 500 \text{ mA}, \ I_B = 50 \text{ mA} \\ \\ I_C &= 20 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 100 \text{ MHz} \\ \\ V_{CB} &= 10 \text{ V}, \ I_E = 0, \\ f &= 140 \text{ kHz} \\ \\ V_{BE} &= 0.5 \text{ V}, \ I_C = 0, \\ f &= 140 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ mA}, \ V_{CE} =$	200 1.5 0.1 60	8.5 30 15 8.0 500	MHz pF pF kΩ x 10 ⁻⁴
fr Ccb Ceb hie hre hfe	GNAL CHARACTERISTICS Current Gain - Bandwidth Product Collector-Base Capacitance Emitter-Base Capacitance Input Impedance Voltage Feedback Ratio Small-Signal Current Gain Output Admittance	$\begin{split} I_C &= 500 \text{ mA}, \ I_B = 50 \text{ mA} \\ I_C &= 20 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 100 \text{ MHz} \\ V_{CB} &= 10 \text{ V}, \ I_E = 0, \\ f &= 140 \text{ kHz} \\ V_{BE} &= 0.5 \text{ V}, \ I_C = 0, \\ f &= 140 \text{ kHz} \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ I_C &= 1.0 \text{ mA}, \ V_{CE} = 10 \text{ V}, \\ f &= 1.0 \text{ kHz} \\ I_C &= 1.0 \text{ kHz} \\ $	200 1.5 0.1 60	1.3 8.5 30 15 8.0 500 100	MHz pF pF kΩ x 10 ⁻⁴

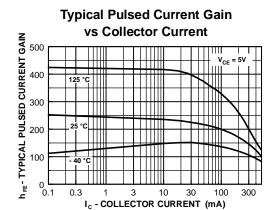
 $I_{B1} = I_{B2} = 15 \text{ mA}$

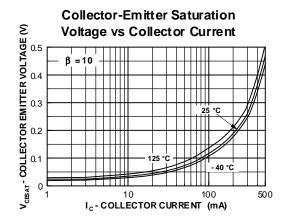
Fall Time

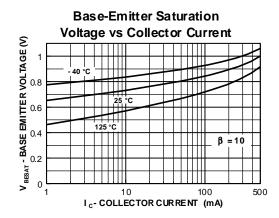
^{*}Pulse Test: Pulse Width £ 300 ms, Duty Cycle £ 2.0%

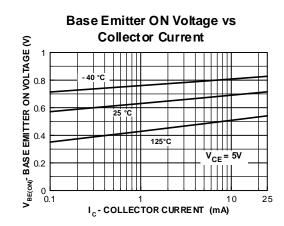
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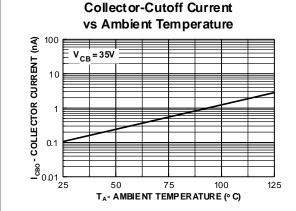
Typical Characteristics

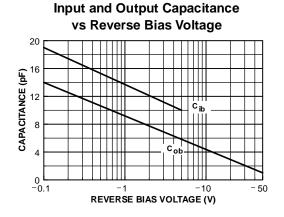








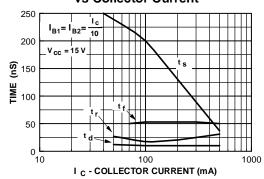




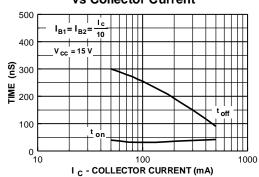
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Typical Characteristics (continued)

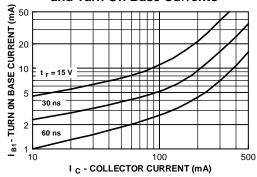
Switching Times vs Collector Current



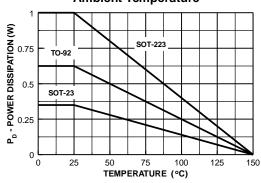
Turn On and Turn Off Times vs Collector Current



Rise Time vs Collector and Turn On Base Currents

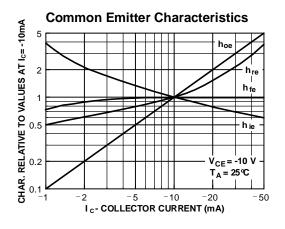


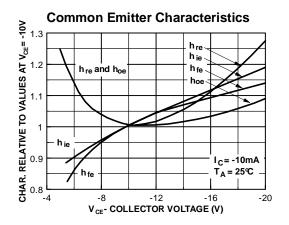
Power Dissipation vs Ambient Temperature

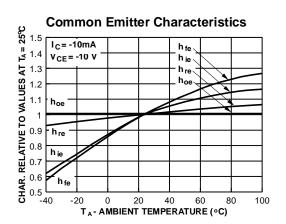


(continued)

Typical Common Emitter Characteristics (f = 1.0kHz)







(continued)

Test Circuits

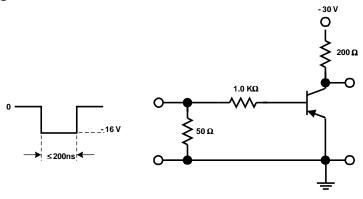


FIGURE 1: Saturated Turn-On Switching Time Test Circuit

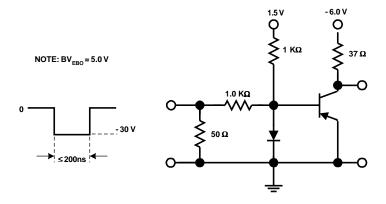


FIGURE 2: Saturated Turn-Off Switching Time Test Circuit

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Definition of Terms

Datasheet Identification	Product Status	Definition
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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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